Update on MgB₂ Thin Film Research for SRF Cavities

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*Presently at JLab







We are trying to demonstrate Gurevich's multi-layer superconductor proposal

Simple single layer example

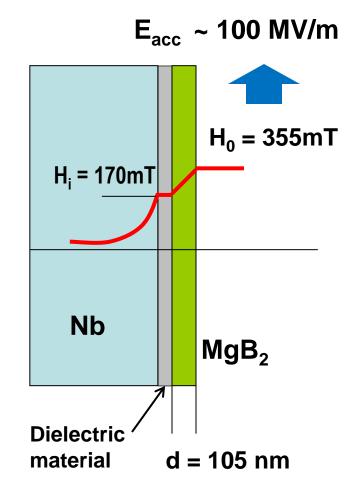
Assumptions

$$H_{c1}(Nb) = 170 \text{ mT}$$

$$\lambda_L(MgB_2) = 140 \text{ nm}$$

$$\xi(MgB_2) = 5 \text{ nm}$$

- $H_{c1}(MgB_2) = 355 \text{ mT}$
- d = 105 nm
- The film thickness needs to be determined so that the decayed field at the Nb surface is below the RF critical field of Nb (~200 mT).









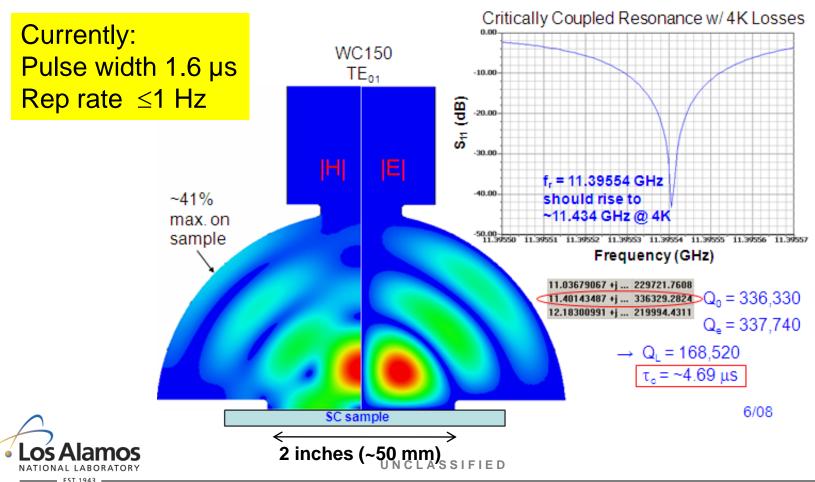






2-inch disk experiments have been carried out at SLAC using a 11.4 GHz 50 MW Klystron to generate short pulses ($\leq 2 \mu s$) and a TE₀₁₃-mode copper hemispheircal host cavity

New Superconducting Sample Test Cavity











The RF breakdown (quench) normally starts on the ring at half radius where the surface magnetic field peaks

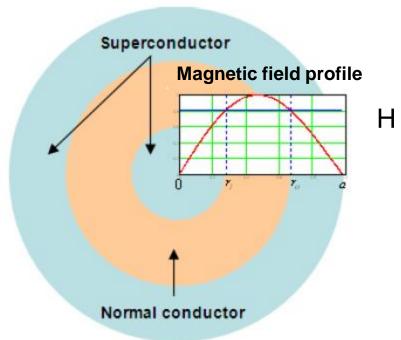
Typical distribution of superconducting and normal-conducting regions after quench

G: Geometrical factor

Sample $Q_0 \propto G_{\text{sample}}/R_{\text{surface}}$



- The cavity Q starts to decrease when part of sample quenches
- One can calculate approx.
 surface resistance from sample Q₀





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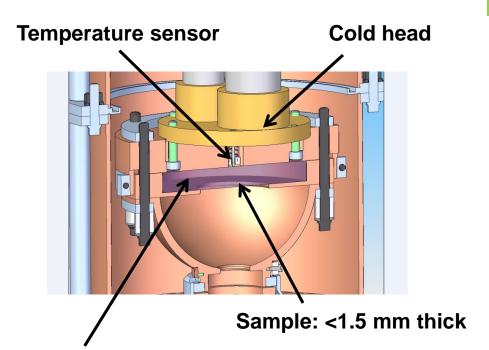




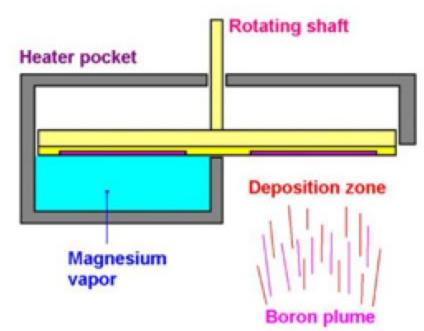
Sample setup detail and current MgB₂ coating method

Sample setup at SLAC

Reactive co-evaporation of MgB₂ at Superconductor Technologies, Inc. (STI), Santa Barbra, CA.



Copper sample holder: 6.35 mm thick



B.H. Moeckly and W.S. Ruby, Supercond. Sci. Technol. 19 (2006) L21–L24

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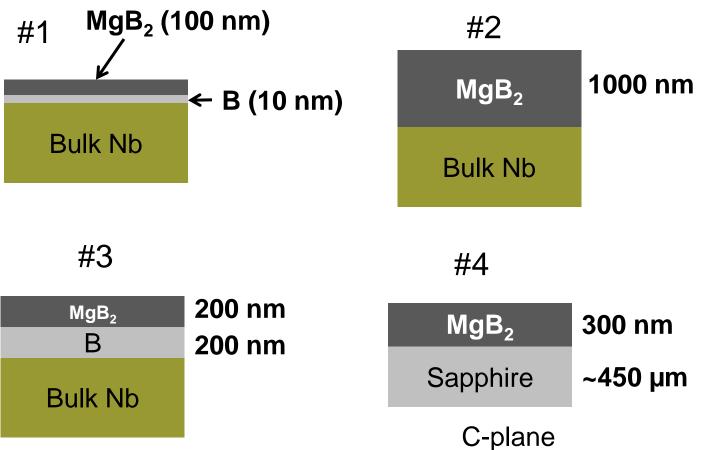








So far, 4 types of coatings have been tried in addition to bare Nb reference samples













Coating #1 Element depth profile

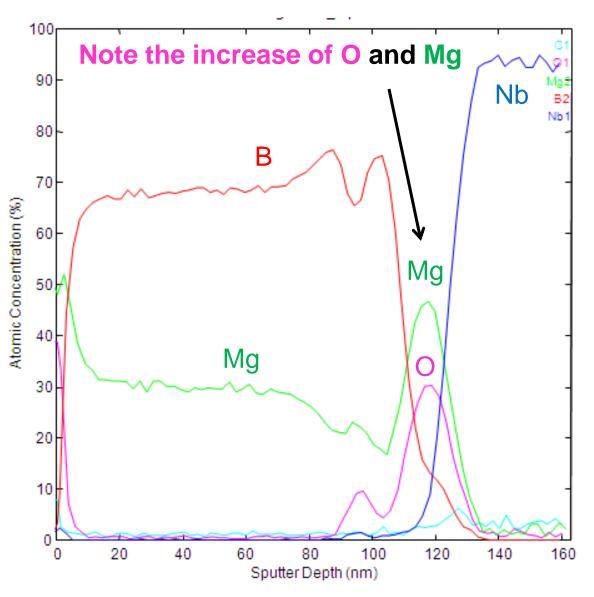
Planned

MgB₂ (100 nm)

Bulk Nb

A number of cracks on MgB₂ were observed after tests.





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Coating #2 Elements depth profile



Planned

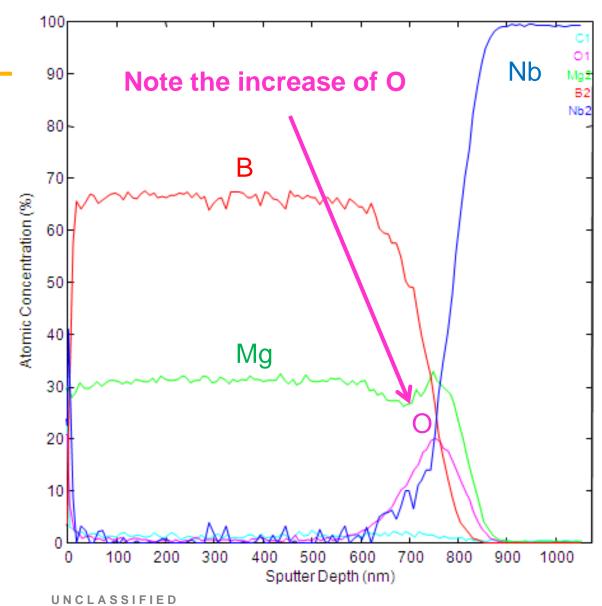


MgB₂ 1000 nm

Bulk Nb

A number of cracks on MgB₂ were observed after tests.













Coating #3 Elements depth profile



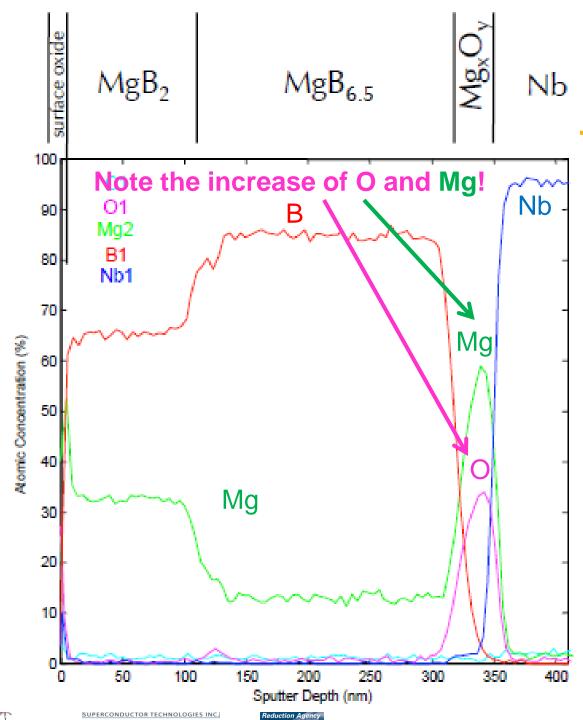
Planned



MgB₂
B
Bulk Nb

200 nm 200 nm





Coating #4 Elements depth profile

Planned



 MgB_2

Sapphire

ppriiie

C-plane

- The actual depth profile showed very small amount of oxygen and very close to the planned coating.
- This indicates that the increased amount of oxygen shown in the previous MgB₂/(B)/Nb systems was from bulk Nb





300 nm

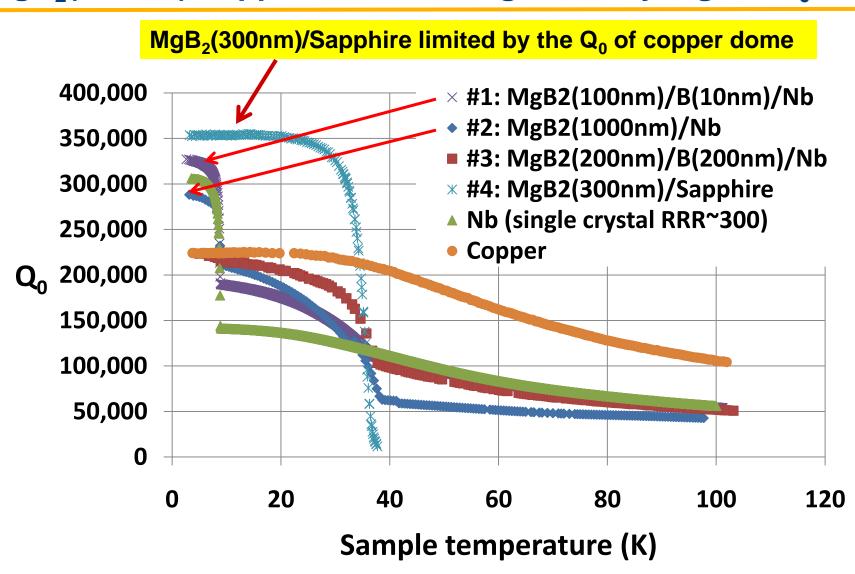
~450 µm



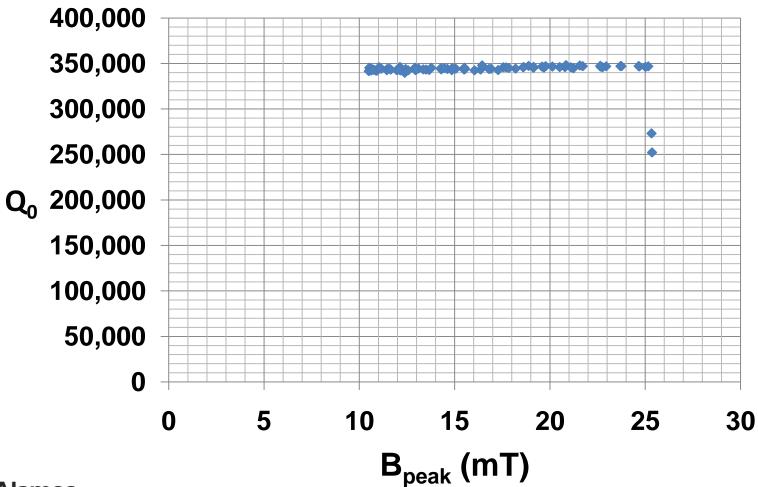




Comparison of low-power Q_0 –T data: MgB₂(300nm)/Sapphire showed significantly higher Q_0



Coating #4, $MgB_2(300nm)/Sapphire$: Q_0 vs. B_{peak} at 3 K MgB_2 quenches at 25 mT (Only one sample has been tested so far.)





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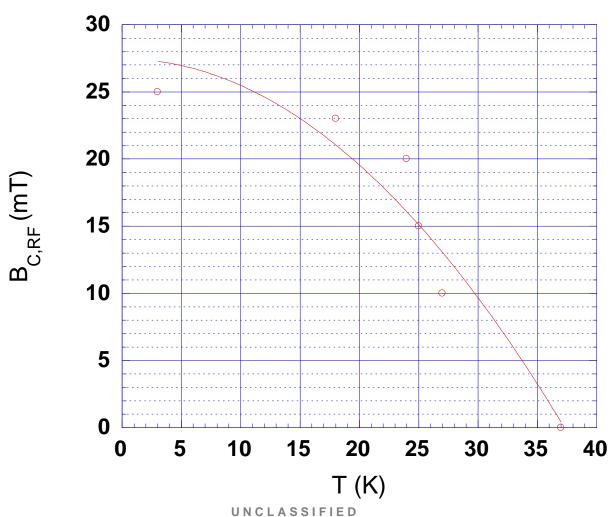
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Coating #4, MgB₂(300nm)/Sapphire: B_{C,RF} vs. T











Measured quench fields at 3 K have been low. For #1-#3, thermal effect due to high surface resistance and effect of cracks are involved and confusing.

Actual T wa	Coating Series No.		Planned coating	Quench field (mT)
		- #1	MgB ₂ (100nm)/B(10nm)/Nb	~30
	_	#2	MgB ₂ (1000nm)/Nb	~30
		_ #3	MgB ₂ (200nm)/B(200nm)/Nb	≤10 (~50 on Nb)
		#4	MgB ₂ (300nm)/Sapphire	25

Nb alone has shown a quench field of 60-70 mT and it is likely to be a thermal quench not magnetic, which is caused by high residual resistance.

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Issues and plans to address them

- Unexpectedly high residual resistance of Nb (~2 m Ω) compared to the expected BCS resistance of ~15 $\mu\Omega$ at 11.4 GHz at 3 K
 - Measure the external magnetic field and try to shield it and see the effect
- The effect of reducing the film thickness has not been seen
 - A series of MgB₂/Al₂O₃/Nb is under test to reduce the reaction between MgB₂ and Nb
 - Try MgB₂ (<100nm)/Al₂O₃/MgB₂ (<100nm)/Al₂O₃/MgB₂ (<100nm)/Sapphire
- Non-uniform coating due to relatively rough surface (R_a >10 nm)
 - We started to use mechanical-chemical polishing by Cabot Microelectronics Polishing Company that produces R_a < 1 nm
- Cracks
 - Changing substrate thickness from ~0.6 to ~1.2 mm has helped.



SIAC







Summary

- We are trying to demonstrate the principle of multilayer superconductor coating to increase the achievable magnetic field
- We have not been successful yet, but there has been increased understanding on what is happening
- Our goal in 2010 is to demonstrate the first milestone of >200 mT (0 K) or equivalent fields at respective temperatures with flat 2-inch diameter samples after addressing some issues that have emerged.











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